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October 2014

FCD850N80Z / FCU850N80Z N-Channel SuperFET[®] II MOSFET

800 V, 6 A, 850 mΩ

Features

- Typ. $R_{DS(on)} = 710 \text{ m}\Omega \text{ (Typ.)}$
- Ultra Low Gate Charge (Typ. Q_g = 22 nC)
- Low E_{oss} (Typ. 2.3 uJ @ 400V)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 106 pF)
- · 100% Avalanche Tested
- RoHS Compliant
- · ESD Improved Capability

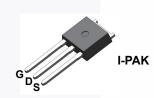
Applications

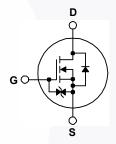
- · AC DC Power Supply
- · LED Lighting

Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress.Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.







$\textbf{Absolute Maximum Ratings} \ T_{\text{C}} = 25^{\text{o}} \text{Cunless otherwise noted}.$

Symbol			FCD850N80Z FCU850N80Z	Unit		
V _{DSS}	Drain to Source Voltage	Drain to Source Voltage				
V	Gate to Source Voltage	- DC	/	±20	V	
V_{GSS}	Gate to Source voltage	- AC	(f > 1 Hz)	±30	V	
I _D	Drain Current	- Continuous (T _C = 25°C)		6	Α	
	Drain Current	- Continuous (T _C = 100°C)		3.8		
I _{DM}	Drain Current	- Pulsed	(Note 1)	18	Α	
E _{AS}	Single Pulsed Avalanche Energy	Single Pulsed Avalanche Energy (Note 2)				
I _{AR}	Avalanche Current		(Note 1)	1.2	Α	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	0.284	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
αν/αι	Peak Diode Recovery dv/dt		(Note 3)	20	V/IIS	
D	Dower Dissipation	(T _C = 25°C)		75	W	
P_{D}	Power Dissipation	0.6	W/°C			
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for	Soldering, 1/8" from Case for 5 S	econds	300	οС	

Thermal Characteristics

Symbol	Parameter FCD850N80Z FCU850N80Z		Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.65	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient, Max.	100	*C/VV

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Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCD850N80Z	FCD850N80Z	DPAK	Tape and Reel	330 mm	16 mm	2500 units
FCU850N80Z	FCU850N80Z	IPAK	Tube	NA	NA	75 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Parameter	Test Conditions	Min.	Тур.	Max.	Unit
cteristics					
Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V, } I_D = 1 \text{ mA, } T_J = 25^{\circ}\text{C}$	800	-	-	V
Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C	-	0.8	-	V/°C
Zero Gate Voltage Drain Current	V _{DS} = 800 V, V _{GS} = 0 V	-	-	25	μА
	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	-	250	
Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±10	μА
	Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current				

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 0.6$ mA	2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$	1	710	850	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 20 \text{ V}, I_{D} = 3 \text{ A}$	1	3.5	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 400 V V 0 V	-\	990	1315	pF
C _{oss}	Output Capacitance	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz	-	28	37	pF
C _{rss}	Reverse Transfer Capacitance	-	-	0.74	-	pF
C _{oss}	Output Capacitance	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	15	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 480 V, V _{GS} = 0 V	-	106	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	V _{DS} = 640 V, I _D = 6 A,	-	22	29	nC
Q_{gs}	Gate to Source Gate Charge	V _{GS} = 10 V	-	5	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	(Note 4)	-	8.6	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	2.4	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		- /	16	42	ns
t _r	Turn-On Rise Time	$V_{DD} = 400 \text{ V}, I_D = 6 \text{ A},$	-/	10	30	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$	-	40	90	ns
t _f	Turn-Off Fall Time	(Note 4)	_	4.5	19	ns

Drain-Source Diode Characteristics

Is	Maximum Continuous Drain to Source Diode Forward Current			-	6	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	18	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 6 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 6 A,	-	318	-	ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100 A/\mu s$	-	4.5	-	μС

Notes:

- 1. Repetitive rating: pulse width limited by maximum junction temperature.
- 2. I_{AS} = 1.2 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25°C
- 3. $I_{SD} \le 6$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting T_J = 25°C
- 4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

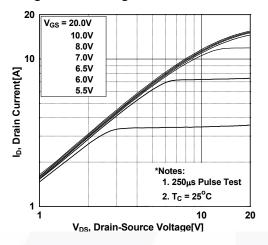


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

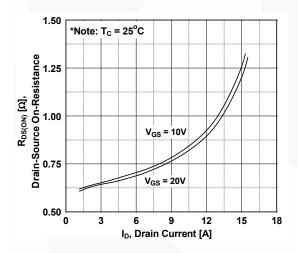


Figure 5. Capacitance Characteristics

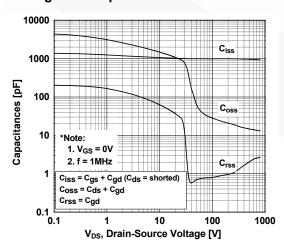


Figure 2. Transfer Characteristics

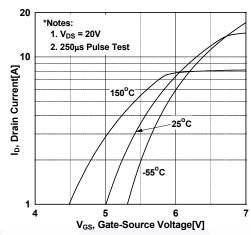


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

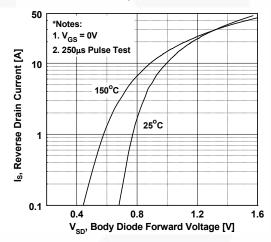
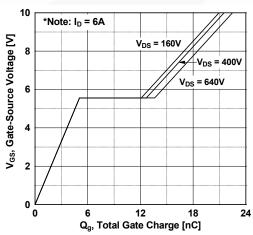


Figure 6. Gate Charge Characteristics



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Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

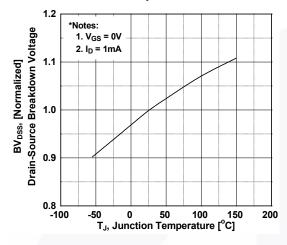


Figure 9. Maximum Safe Operating Area

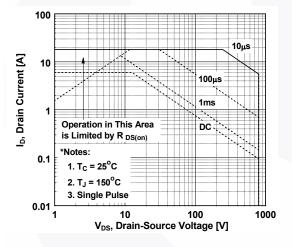


Figure 11. Eoss vs. Drain to Source Voltage

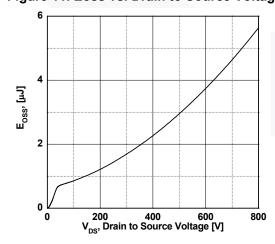


Figure 8. On-Resistance Variation vs. Temperature

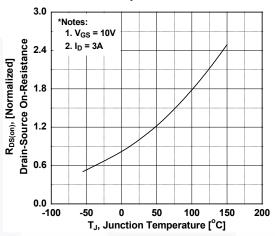
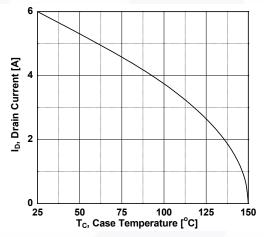


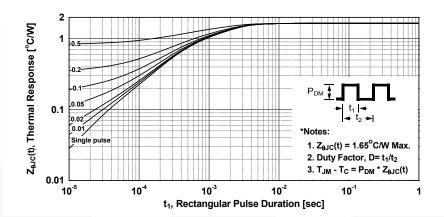
Figure 10. Maximum Drain Current vs. Case Temperature



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Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve



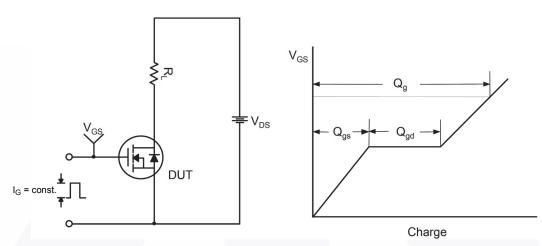


Figure 13. Gate Charge Test Circuit & Waveform

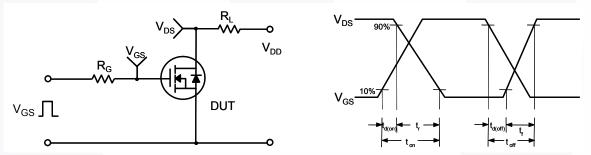


Figure 14. Resistive Switching Test Circuit & Waveforms

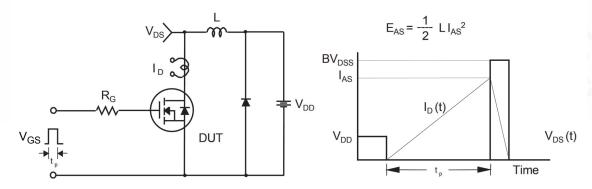


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

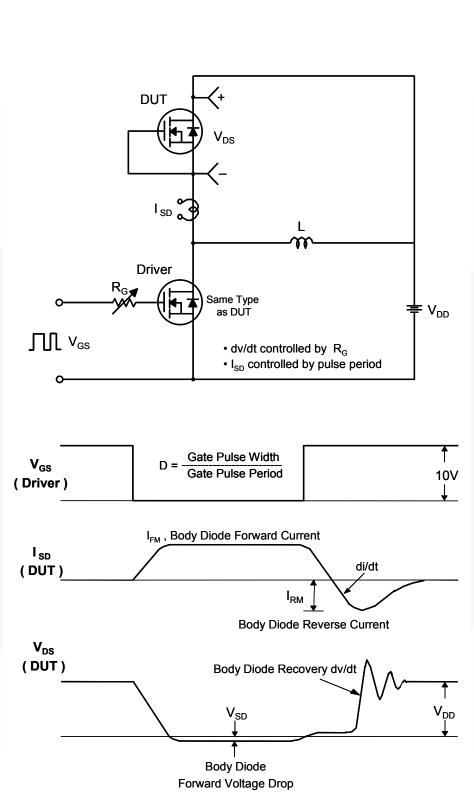
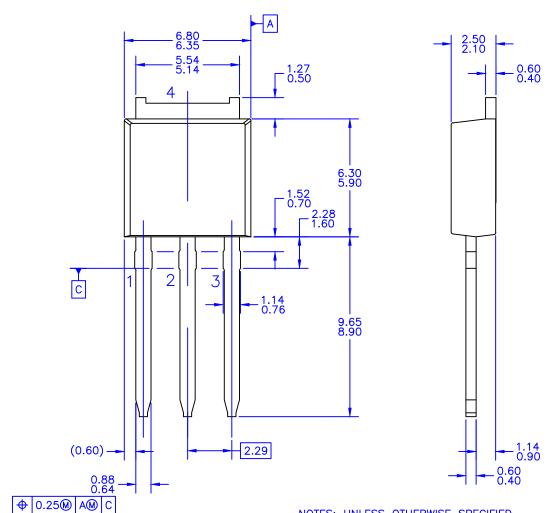
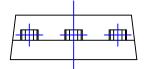


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms



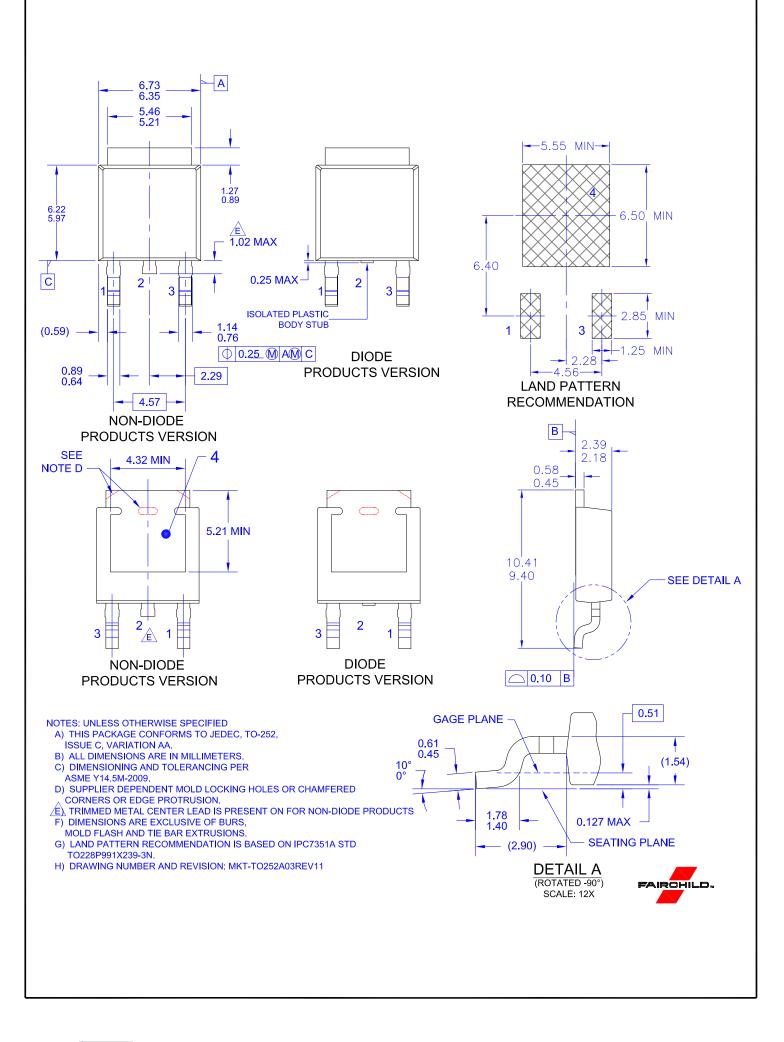


3 PLCS

NOTES: UNLESS OTHERWISE SPECIFIED

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